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TRENCHSTOP[™] Series

Low Loss DuoPack : IGBT in TRENCHSTOPTM and Fieldstop technology with soft, fast recovery anti-parallel Emitter Controlled HE diode

- Very low V_{CE(sat)} 1.5V (typ.)
- Maximum Junction Temperature 175°C
- Short circuit withstand time 5µs
 - Designed for:
 - Frequency Converters
 - Drives
 - TRENCHSTOPTM and Fieldstop technology for 600V applications offers:
 - very tight parameter distribution
 - high ruggedness, temperature stable behavior
 - very high switching speed
 - Iow V_{CE(sat)}
- Positive temperature coefficient in V_{CE(sat)}
- Low EMI

•

- Low Gate Charge
- Very soft, fast recovery anti-parallel Emitter Controlled HE diode
- Qualified according to JEDEC¹⁾ for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models: <u>http://www.infineon.com/igbt/</u>

Туре	V _{CE}	<i>I</i> c	V _{CE(sat),Tj=25℃}	T _{j,max}	Marking	Package
IKP04N60T	600V	4A	1.5V	175°C	K04T60	PG-TO220-3

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage, $T_j \ge 25^{\circ}C$	V _{CE}	600	V
DC collector current, limited by T_{jmax} $T_{C} = 25^{\circ}C$ $T_{C} = 100^{\circ}C$	I _C	9.5 6.5	
Pulsed collector current, t_p limited by T_{jmax}	I _{Cpuls}	12	•
Turn off safe operating area, $V_{CE} = 600V$, $T_j = 175^{\circ}C$, $t_p = 1\mu s$	-	12	— A
Diode forward current, limited by Tjmax $T_{\rm C} = 25^{\circ}{\rm C}$ $T_{\rm C} = 100^{\circ}{\rm C}$	I _F	9.5 6.5	
Diode pulsed current, t_p limited by T_{jmax}	I _{Fpuls}	12	
Gate-emitter voltage	V _{GE}	±20	V
Short circuit withstand time ²⁾ $V_{GE} = 15V, V_{CC} \le 400V, T_j \le 150^{\circ}C$	tsc	5	μS
Power dissipation $T_{\rm C} = 25^{\circ}{\rm C}$	Ptot	42	W
Operating junction temperature	Tj	-40+175	
Storage temperature	T _{stg}	-55+150	°C
Soldering temperature, 1.6mm (0.063 in.) from case for 10s	-	260	

¹⁾ J-STD-020 and JESD-022

²⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.





RoHS



TRENCHSTOP[™] Series

Thermal Resistance

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic				
IGBT thermal resistance,	0		0.5	
junction – case	$R_{ m thJC}$		3.5	
Diode thermal resistance,	D			
junction – case	$R_{ m thJCD}$		5	K/W
Thermal resistance,			60	1
junction – ambient	$R_{ m thJA}$		62	

Electrical Characteristic, at $T_j = 25^{\circ}C$, unless otherwise specified

Deveryotar	Cumula al	O a maliti a ma	Value			11	
Parameter	Symbol	Conditions	min.	Тур.	max.	Unit	
Static Characteristic		·					
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{\rm GE} = 0 \rm V, \ I_{\rm C} = 0.2 \rm m A$	600	-	-		
		$V_{\rm GE} = 15 \rm V, \ I_{\rm C} = 4 \rm A$					
Collector-emitter saturation voltage	V _{CE(sat)}	<i>T</i> _j =25°C	-	1.5	2.05		
		<i>T</i> _j =175°C	-	1.9	-		
Diada famuand calkana		$V_{GE}=0V, I_{F}=4A$				V	
Diode forward voltage	VF	<i>T</i> _j =25°C	-	1.65	2.05		
		<i>T</i> _j =175°C	-	1.6	-		
Gate-emitter threshold voltage	V _{GE(th)}	$I_{\rm C}=60\mu {\rm A}, V_{\rm CE}=V_{\rm GE}$	4.1	4.9	5.7		
		$V_{\rm CE} = 600 \text{V}, \ V_{\rm GE} = 0 \text{V}$					
Zero gate voltage collector current	ICES	<i>T</i> _j =25°C					
		<i>T</i> _j =175°C	-	-	40	μA	
			-	-	1000		
Gate-emitter leakage current	IGES	$V_{CE}=0V, V_{GE}=20V$	-	-	100	nA	
Transconductance	$g_{ m fs}$	$V_{\rm CE} = 20 \text{V}, \ I_{\rm C} = 4 \text{A}$	-	2.2	-	S	
Integrated gate resistor	R _{Gint}			-	•	Ω	

Dynamic Characteristic

Input capacitance	Cies	V _{CE} =25V,	-	252	-	
Output capacitance	Coes	$V_{\rm GE}=0V$,	-	20	-	pF
Reverse transfer capacitance	Cres	f=1MHz	-	7.5	-	
Gate charge	Q_{Gate}	V _{CC} =480V, I _C =4A V _{GE} =15V	-	27	-	nC
Internal emitter inductance measured 5mm (0.197 in.) from case	LE		-	7	-	nH
Short circuit collector current ¹⁾	I _{C(SC)}	$V_{GE} = 15V, t_{SC} \le 5\mu s$ $V_{CC} = 400V, T_j \le 150^{\circ}C$	-	36	-	A

¹⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.



TRENCHSTOP[™] Series

Paramotor	Symbol	Conditions	Value			Limit
Parameter	Symbol		min.	Тур.	max.	Unit
IGBT Characteristic						
Turn-on delay time	t _{d(on)}	<i>T</i> _j =25°C,	-	14	-	
Rise time	t _r	$V_{\rm CC} = 400 \text{V}, I_{\rm C} = 4 \text{A},$	-	7	-	1
Turn-off delay time	$t_{d(off)}$	$V_{\rm GE} = 0/15 V,$ $R_{\rm G} = 47 \Omega,$	-	164	-	ns
Fall time	t _f	$L_{\sigma}^{(1)} = 150 \text{nH},$	-	43	-	
Turn-on energy	Eon	$C_{\sigma}^{(1)} = 47 \text{pF}$	-	61	-	
Turn-off energy	E _{off}	Energy losses include "tail" and diode	-	84	-	μJ
Total switching energy	Ets	reverse recovery.	-	145	-	
Anti-Parallel Diode Characteristic		·				
Diode reverse recovery time	t _{rr}	<i>T</i> _j =25°C,	-	28	-	ns
Diode reverse recovery charge	Q _{rr}	$V_{\rm R}$ =400V, $I_{\rm F}$ =4A,	-	79	-	nC
Diode peak reverse recovery current	<i>I</i> _{rrm}	di _F /dt=610A/µs	-	5.3	-	А
Diode peak rate of fall of reverse recovery current during $t_{\rm b}$	di _{rr} /dt		-	346	-	A/µs

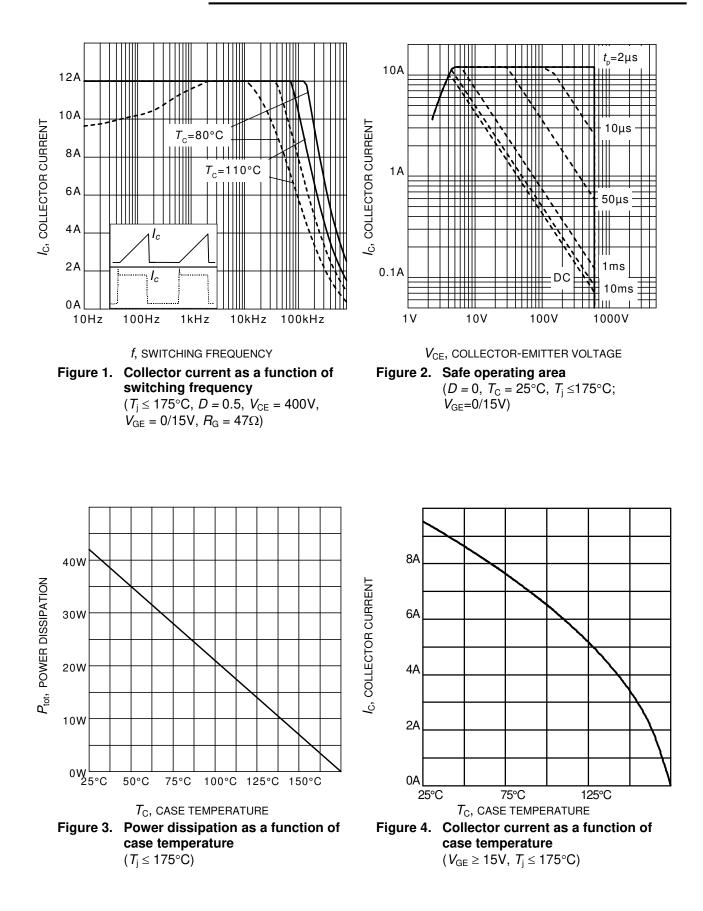
Switching Characteristic, Inductive Load, at $T_i=25$ °C

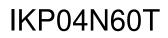
Switching Characteristic, Inductive Load, at $T_j=175^{\circ}C$

Devenuedev	Ourseland	O a su all'il la su a	Value			
Parameter	Symbol	Conditions	min.	Тур.	max.	Unit
IGBT Characteristic						
Turn-on delay time	t _{d(on)}	<i>T</i> _j =175°C,	-	14	-	
Rise time	t _r	$V_{\rm CC} = 400 \text{V}, I_{\rm C} = 4 \text{A},$	-	10	-	1
Turn-off delay time	t _{d(off)}	$V_{\rm GE} = 0/15 \rm V,$ $R_{\rm G} = 47 \Omega$	-	185	-	ns
Fall time	t _f	$L_{\sigma}^{(1)} = 150 \text{ nH},$ $C_{\sigma}^{(1)} = 47 \text{ pF}$	-	83	-	1
Turn-on energy	Eon		-	99	-	
Turn-off energy	E _{off}	Energy losses include "tail" and diode	-	97	-	μJ
Total switching energy	Ets	reverse recovery.	-	196	-	
Anti-Parallel Diode Characteristic	1	1				
Diode reverse recovery time	t _{rr}	<i>T</i> _i =175°C	-	95	-	ns
Diode reverse recovery charge	Q _{rr}	$V_{\rm R}$ =400V, $I_{\rm F}$ =4A,	-	291	-	nC
Diode peak reverse recovery current	<i>I</i> _{rrm}	di _F /dt=610A/µs	-	6.6	-	Α
Diode peak rate of fall of reverse recovery current during $t_{\rm b}$	di _{rr} /dt		-	253	-	A/μs

 $^{1)}$ Leakage inductance L_{σ} and Stray capacity \mathcal{C}_{σ} due to dynamic test circuit in Figure E.

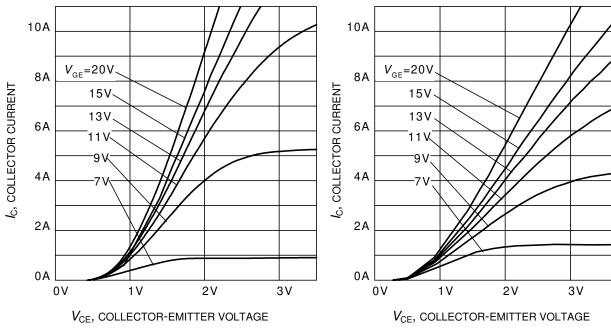


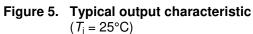


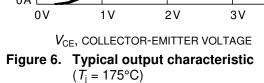


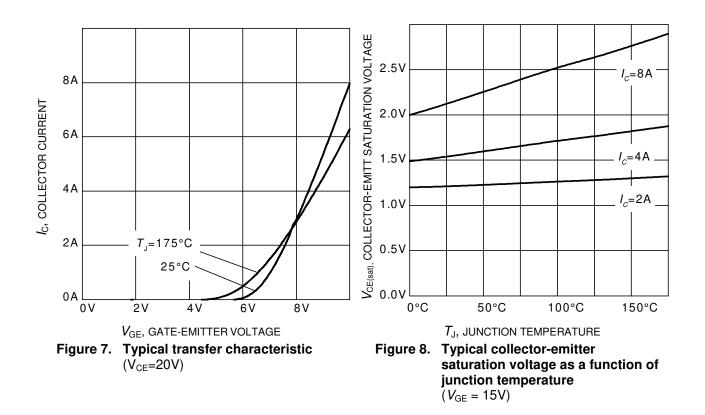


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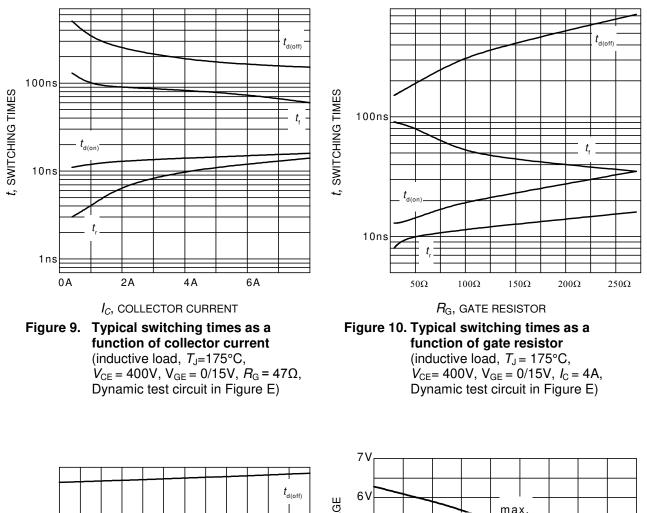


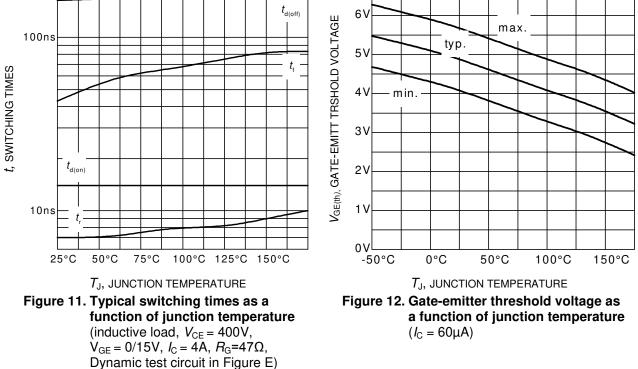






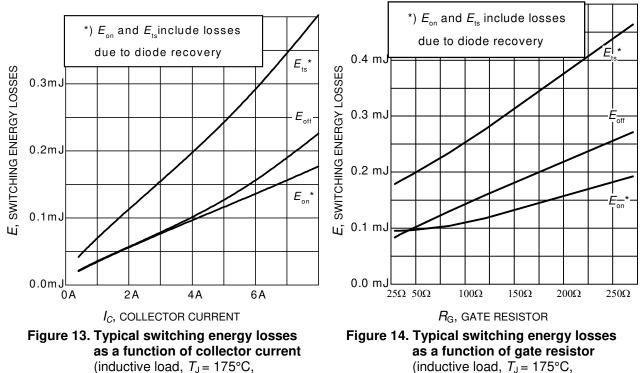




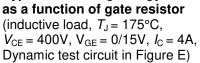


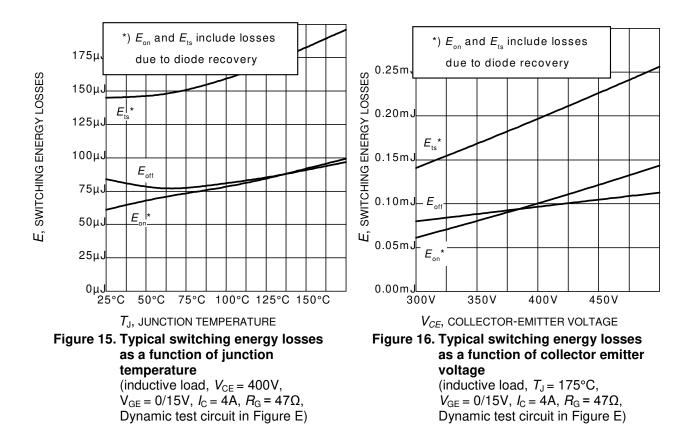


TRENCHSTOP[™] Series



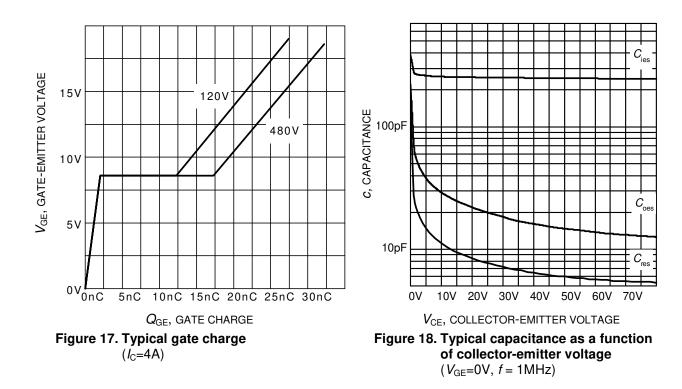
 $V_{CE} = 400V, V_{GE} = 0/15V, R_G = 47\Omega,$ Dynamic test circuit in Figure E)

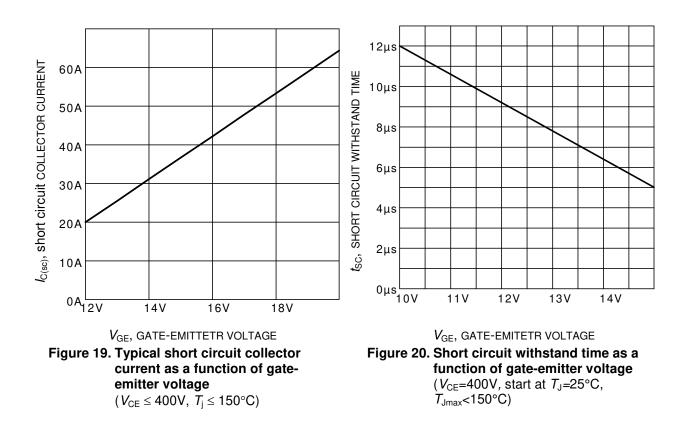




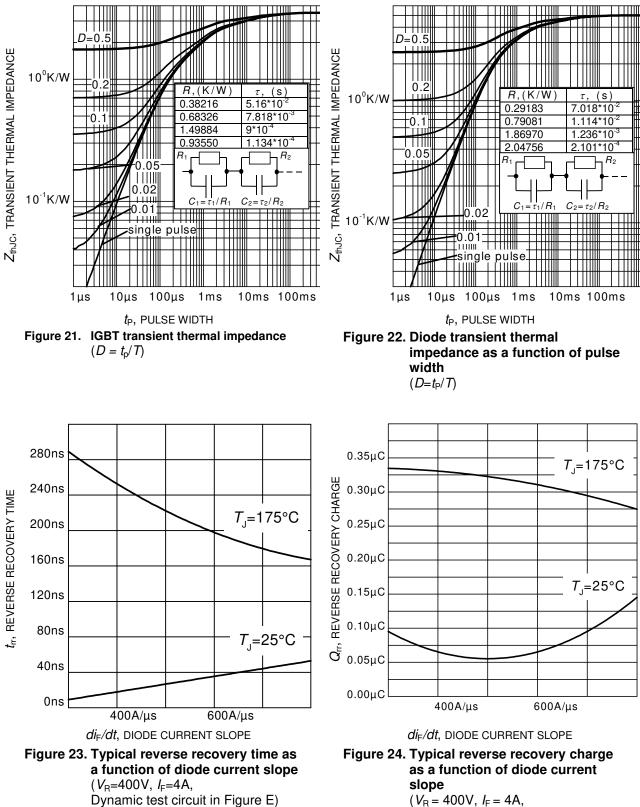


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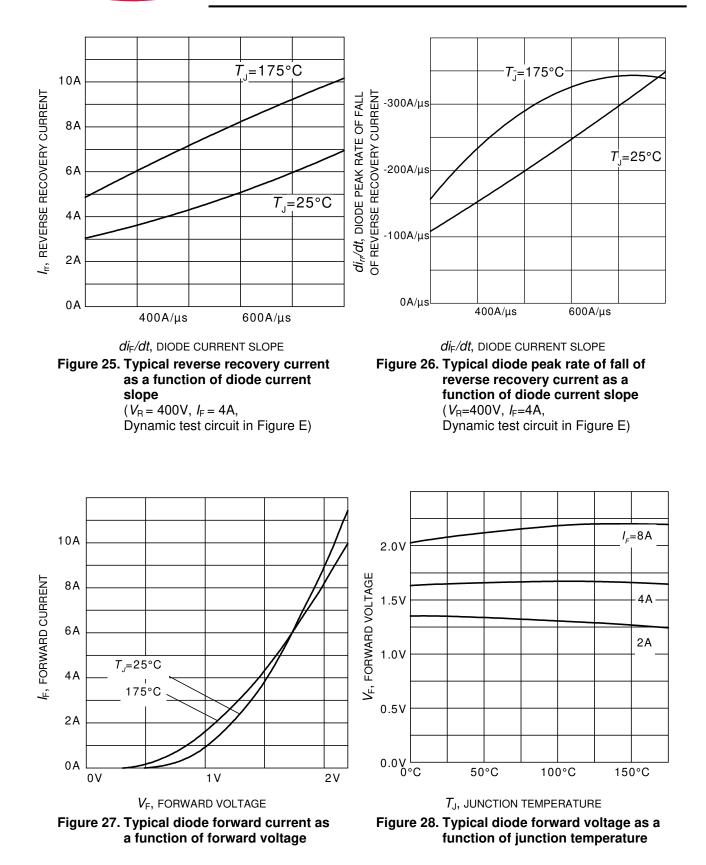








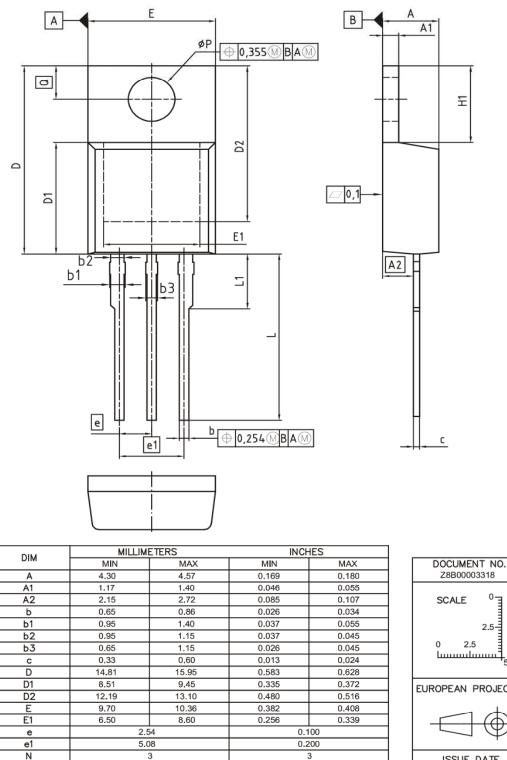


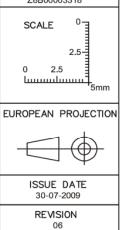




TRENCHSTOP[™] Series

Package Drawing PG-TO220-3





H1

L

L1

øP

Q

5,90

13.00

3.60

2.60

0.232

0.512

0.142

0.102

0,272

0.551

0.189

0.153

0.118

6,90

14.00

4.80

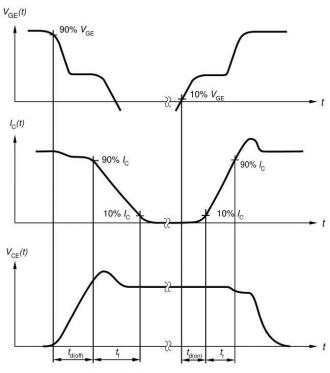
3.89

3.00

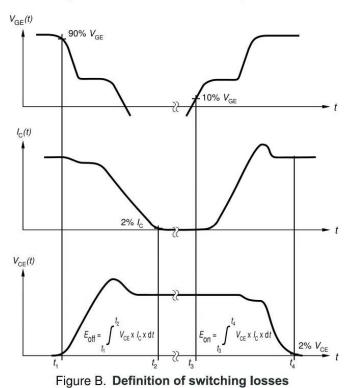


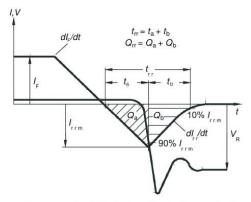
TRENCHSTOP[™] Series

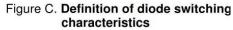
Testing Conditions











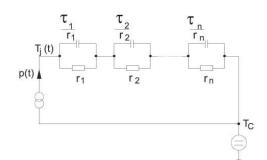


Figure D. Thermal equivalent circuit

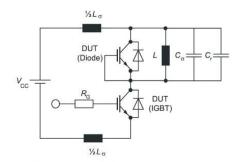


Figure E. Dynamic test circuit Parasitic inductance L_{σ} , parasitic capacitor C_{σ} , relief capacitor C_{r} , (only for ZVT switching)



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